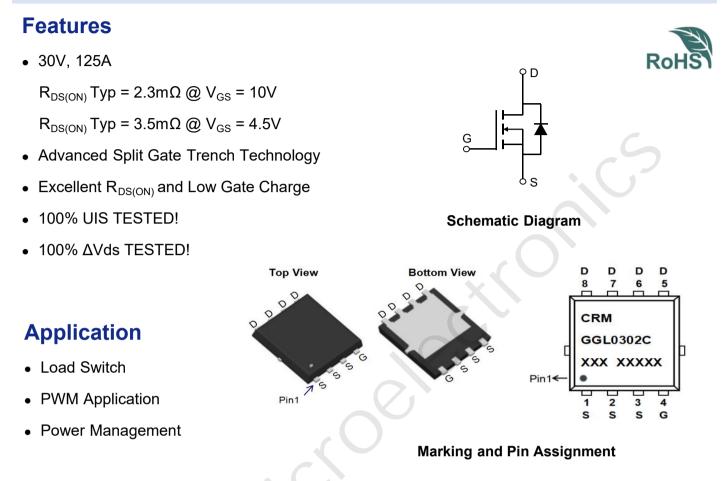


CRMGGL0302C N-Channel 30V, 2.3mΩ Typ. Power MOSFET

Description



Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGGL0302C	CRMGGL0302C	PDFN5x6-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		30	V
V _{GS}	Gate-to-Source Voltage		±20	V
	T _C = 25°C	125	А	
I _D		T _C = 100°C	75	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		500	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		90	mJ
P_{D}	Power Dissipation	T _C = 25°C	79	W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case		1.58	°C/W
Τ J, T _{STG}	Junction & Storage Temperature Range		-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{\rm D} = 250 \mu A$, $V_{\rm GS} = 0 V$	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 30V, V _{GS} = 0V	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	1.2	1.7	2.4	V
	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 12A	-	2.3	3	mΩ
$R_{DS(ON)}$		V _{GS} = 4.5V, I _D = 8A	-	3.5	4.6	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	1837	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 15V, f = 1MHz	Χ-	1606	-	pF
C _{rss}	Reverse Transfer Capacitance			83	-	pF
Q _g	Total Gate Charge	0	<u> </u>	31	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 15V$, $I_{D} = 20A$	-	5.8	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$v_{\rm DS} = 100, v_{\rm D} = 200$	-	6	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	14	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 15V	-	7	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 3 Ω	-	35	-	ns
t _f	Turn-Off Fall Time		-	7	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _S	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	125	А
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	500	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 10A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	50	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 15A, di/dt = 100A/us	-	20	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting $T_J{=}25^{\circ}C,\,V_{DD}{=}15V,\,V_{G}{=}10V,\,R_{G}{=}25ohm,\,L{=}0.5mH,\,I_{AS}{=}19A$

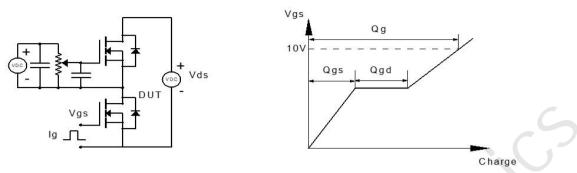
3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 0.5%.



CRMGGL0302C

N-Channel 30V, 2.3mΩ Typ. Power MOSFET

Test Circuit





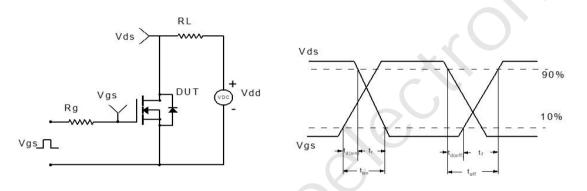
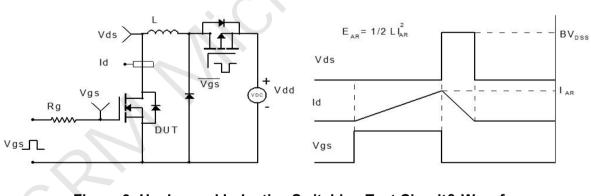
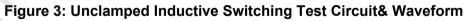


Figure 2: Resistive Switching Test Circuit & Waveform





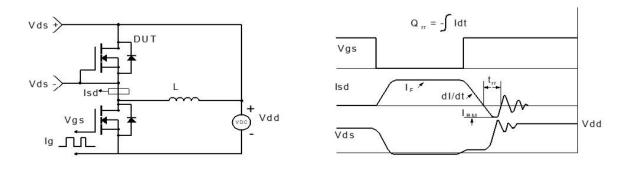


Figure 4: Diode Recovery Test Circuit & Waveform

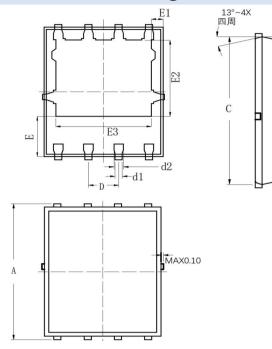


CRMGGL0302C

N-Channel 30V, 2.3mΩ Typ. Power MOSFET

Package Mechanical Data(PDFN5x6-8L)

13°~4X 四周



<u> </u>				
b1	1		1	1
	d	 	h	<u> </u>

COMMON DIMENSION (MM)						
PKG	PDFN 5×6-8L					
SYMBOL	MIN	TYP	MAX			
A	6.000	6.100	6.200			
В	4.875	4.900	4.925			
b1	0.975	1.000	1.025			
b2	0.246	0.254	0.262			
С	5.775	5.800	5.825			
D	1.245	1.270	1.295			
d1	0.275	0.300	0.325			
d2	0.375	0.400	0.425			
E	1.725	1.775	1.825			
E1	0.395	0.445	0.495			
E2	3.425	3.475	3.525			
E3	3.960	4.010	4.060			

Important Notice

The information presented in datasheets is for reference only. CRM reserves the right to make changes at any time to any products or information herein, without notice. Customers are responsible for the design and applications, including compliance

with all laws, regulations and safety requirements or standards.

"Typical" parameters which provided in datasheets can vary in different applications and actual performance may vary over time. Customers are responsible for doing all necessary testing to minimize the risks associated with their applications and products.

is a registered trademark of Wuxi CRM Microelectronics Co. , Ltd. Copyright ©2023 CRM Microelectronics Co. , Ltd. All rights reserved.

Contact information

For more information, please visit: http://www.crm-semi.tech For sales information, please send an email to: sales@crm-semi.com